# **40V SILICON HIGH CURRENT LOW LEAKAGE SCHOTTKY DIODE**

### **SUMMARY**

Schottky Diode  $V_R$  = 40V;  $I_F$  = 0.7A;  $I_R$  = 10 $\mu$ A

### **DESCRIPTION**

This compact SOT23 packaged Schottky diode offers users an excellent performance combination comprising high current operation, extremely low leakage and low forward voltage ensuring suitability for applications requiring efficient operation at higher temperatures (above 85°C) see Operational Efficiency chart on page 4.



Cathode

### Key benefits:

Performance capability equivalent to much larger packages

Improved circuit efficiency & power levels

PCB area savings

### **FEATURES**

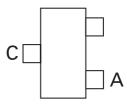
- Extremely Low Leakage (10µA @30V)
- High current capability (I<sub>F</sub> = 0.7A)
- Low V<sub>F</sub>, Fast switching Schottky
- SOT23 Package
- ZLLS500 complements low temperature equivalent ZHCS500
- Package thermally rated to 150°C

# **APPLICATIONS**

- DC DC Converters
- Strobes
- Mobile Phones
- Charging Circuits
- Motor control

### **ORDERING INFORMATION**

DEVICE			QUANTITY PER REEL
ZLLS500TA	7	8mm embossed	3000 units
ZLLS500TC	13	8mm embossed	10000 units



Anode

### Top view

### **DEVICE MARKING**

L05



### **ABSOLUTE MAXIMUM RATINGS.**

PARAMETER		SYMBOL	VALUE	UNIT
Schottky Diode			•	•
Continuous Reverse Voltage	V <sub>R</sub>	40	V	
Forward Current	I <sub>F</sub>	0.7	А	
Peak Repetitive Forward Current		I <sub>FPK</sub>	1.14	А
Rectangular Pulse Duty Cycle				
Non Repetitive Forward Current	t=≤100μs	I <sub>FSM</sub>	13	А
	t=≤10ms		3.2	A
Package				
Power Dissipation at T <sub>amb</sub> =25°C single die continuous		P <sub>D</sub>	500	mW
single die measured at t<5 secs			630	mW
Storage Temperature Range		T <sub>stg</sub>	-55 to +150	°C
Junction Temperature		ті	150	°C

# THERMAL RESISTANCE

PARAMETER	SYMBOL	VALUE	UNIT
Junction to Ambient (a)	$R_{\Theta JA}$	250	°C/W
Junction to Ambient (b)	$R_{\Theta JA}$	198	°C/W

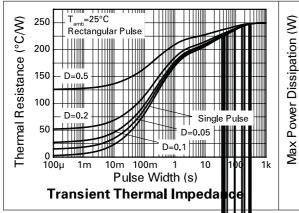
## Notes

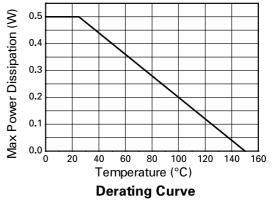
(a) For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

(b) For a device surface mounted on FR4 PCB measured at t<5secs.



# **TYPICAL CHARACTERISTICS**





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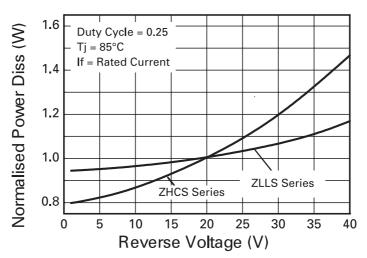
### **ELECTRICAL CHARACTERISTICS** (at Tamb = 25°C unless otherwise stated).

SCHOTTKY DIODE CHARACTERISTICS						
Reverse Breakdown Voltage	V <sub>(BR)R</sub>	40			V	I <sub>R</sub> =500μA
Forward Voltage	V <sub>F</sub>		310	350	mV	I <sub>F</sub> =50 mA*
			350	400	mV	I <sub>F</sub> =100 mA*
			425	520	mV	I <sub>F</sub> =250mA*
			520	610	mV	I <sub>F</sub> =400mA*
			610	850	mV	I <sub>F</sub> =750mA*
			690	1000	mV	I <sub>F</sub> =1000mA*
			860	1300	mV	I <sub>F</sub> =1500mA*
			494		mV	I <sub>F</sub> =500mA*,Ta = 100°C
Reverse Current	I <sub>R</sub>		5.5	10	μΑ	V <sub>R</sub> =30V
			370		μΑ	$V_R = 30V, Ta = 85^{\circ}C$
Diode Capacitance	C <sub>D</sub>		15.5		pF	f=1MHz,VR=30V
Reverse Recovery Time	t <sub>rr</sub>		2.46		ns	Switched from I <sub>F</sub> = 500mA
Reverse Recovery Charge	Q <sub>rr</sub>		1.38		nC	to $V_R$ = 5V. Measured @ $I_R$ 50mA. di / dt > 1A / ns.
						Rsource = 6 ohm.

<sup>\*</sup>Measured under pulsed conditions.

## **Operational Efficiency chart**

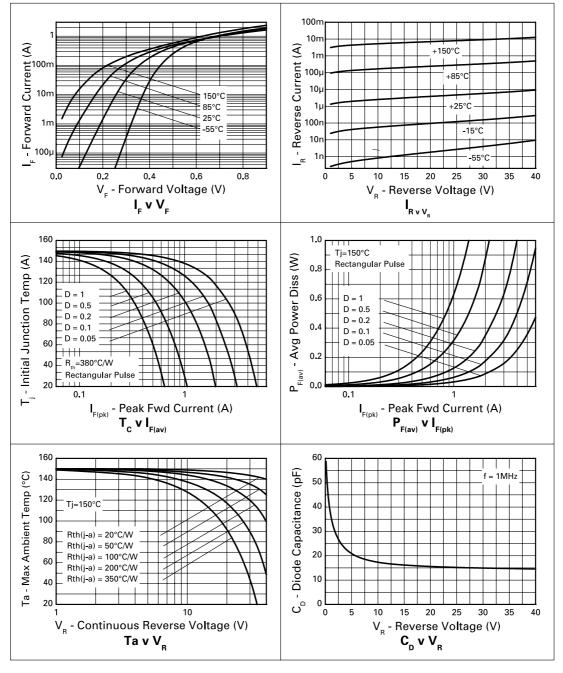
The operational efficiency chart indicates the beneficial use of the ZLLS Series diodes in applications requiring higher voltage, higher temperature operation. Circuits requiring Low voltage Low temperature operation will benefit from using Zetex low  $V_F$  ZHCS Series diodes.



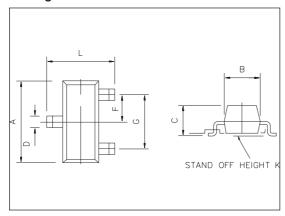
**Operational Efficiency Example** 



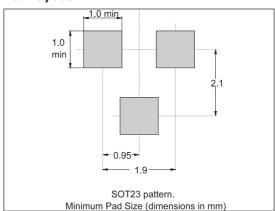
## **TYPICAL CHARACTERISTICS**



### **Package Outline**



### **Pad Layout**



### **Package Dimensions**

DIM	Millim	netres	Inches		
DIIVI	Min	Max	Min	Max	
Α	2.67	3.05	0.105	0.120	
В	1.20	1.40	0.047	0.055	
С	ı	1.10	-	0.043	
D	0.37	0.53	0.0145	0.021	
F	0.085	0.15	0.0033	0.0059	
G	NOM 1.9		NOM 0.075		
K	0.01	0.10	0.0004	0.004	
L	2.10	2.50	0.0825	0.0985	
N	NOM 0.95		NOM 0.037		

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